

PRODUCT AND PROCESS CHANGE NOTIFICATION UPDATE

Generic Copy

ISSUE DATE:	10-Jun-2010
NOTIFICATION:	13675B
TITLE:	FREESCALE 150MM SENDAI FAB CLOSURE - 60% IDRNVM TO CHD PRODUCT TRANSFER NOTIFICATION
EFFECTIVE DATE:	31-Mar-2011

DEVICE(S)

MPN	
MC11E1CPBE2	
MC68711E20CFNE2	
MC68711E20CFNE3	
MC68711E20CFNE4	
MC68711E20CFUE3	
MC68711E20CFUE4	
MC68711E20MFNE2	
MC68711E20VFNE2	
MC68HC11E0CFNE2	
MC68HC11E0CFNE2R	
MC68HC11E0CFNE3	
MC68HC11E0CFNE3R	
MC68HC11E0MFNE2	
MC68HC11E1CFNE2	
MC68HC11E1CFNE2R	
MC68HC11E1CFNE3	
MC68HC11E1CFNE3R	
MC68HC11E1MFNE2	
MC68HC11E1MFNE3	
MC68HC11E1VFNE3	
MC68HC11E9BCFNE2	
MC68HC705C8ACFNE	
MC68HC705C8AFNE	
MC68HC705C9ACFBE	

AFFECTED CHANGE CATEGORIES

FAB SITE

DESCRIPTION OF CHANGE

This notice updates the list of devices that will be transferred. Please review this update as your device list may have changed.

The device(s) listed in this notification are being transferred from the Sendai Fab to the Freescale Chandler Fab.

For any derivative devices of products on this list that customers may request subsequent to this notice, the terms of this notice will apply.

No change to the orderable part number, except only lead-free, EPP package devices will be orderable.

REASON FOR CHANGE

This notice updates the affected device list. Please review this update as your device list may have changed.

Please note that the 711E9 family will not be transferred and is now being discontinued (see PCN#13644B and 13644C), however for most applications a compatible 711E20 part may be a potential replacement part.

Please contact your Sales Rep for possible replacement part information.

In order to improve our manufacturing efficiency, we have made the decision to refocus our manufacturing on 200mm and 300mm technology and to ramp down 150mm manufacturing, resulting in the closure of the Sendai Fab.

ANTICIPATED IMPACT OF PRODUCT CHANGE(FORM, FIT, FUNCTION, OR RELIABILITY)

All devices will be transferred and qualified in lead-free, EPP packages only.

Contact your Sales representative regarding replacement products.

Anticipated AEC-Q100 Qualification Date: as there are multiple devices, the qualification dates are distributed from Jan'11 through Jun '11.

Anticipated Sample Availability Date: as there are multiple devices, the qualification dates are distributed from Jan'11 through Jun '11.

Updates to these schedules will be provided through your Sales rep as the qualifications progress.

Please provide sample requests by Sept 2010

ROM and Programmed Flash sample availability will be dependent on customer code availability and factory lead times.

Freescale will consider specific conditions of acceptance of this change submitted within 30 days of receipt of this notice on a case by case basis. To request further data or inquire about samples, please enter a <u>Service Request.</u>

RELATED NOTIFICATION(S): <u>13675A</u> - FREESCALE 150MM SENDAI FAB CLOSURE - 60% IDRNVM TO CHD PRODUCT TRANSFER NOTIFICATION

TO VIEW the GENERIC copy, click on the notification number above.

QUALIFICATION STATUS: IN PROCESS

QUALIFICATION PLAN:

This data will be provided per the schedule in the anticipated impact section.

RELIABILITY DATA SUMMARY:

This data will be provided per the schedule in the anticipated impact section.

ELECTRICAL CHARACTERISTIC SUMMARY:

This data will be provided per the schedule in the anticipated impact section.

CHANGED PART IDENTIFICATION:

No change to the orderable part number, except only lead-free, EPP package devices will be orderable.

ATTACHMENT(S): N/A